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Vishay Siliconix

RoHS

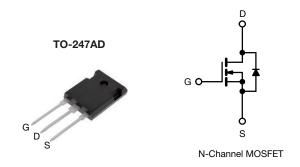
COMPLIANT

HALOGEN

FREE

E Series Power MOSFET with Fast Body Diode

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	700				
R _{DS(on)} typ. at 25 °C (Ω)	V _{GS} = 10 V	0.041			
Q _g max. (nC)	371				
Q _{gs} (nC)	65				
Q _{gd} (nC)	93				
Configuration	Single				



FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Low switching losses due to reduced Q_{rr}
- Ultra low gate charge (Qa)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
- High-intensity lighting (HID)
- Light emitting diodes (LEDs)
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
- Battery chargers
- Renewable energy
 - Solar (PV inverters)
- Switching mode power supplies (SMPS)
- · Applications using the following topologies
 - LLC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-Free and Halogen-Free	SiHW61N65EF-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	650	V	
Gate-Source Voltage			V_{GS}	± 30	V	
Continuous Proin Current (T = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	64	А	
Continuous Drain Current ($T_J = 150 ^{\circ}$ C)		T _C = 100 °C		41		
Pulsed Drain Current ^a			I _{DM}	199		
Linear Derating Factor				4.2	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	1142	mJ	
Maximum Power Dissipation			P _D	520	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope $T_J = 125 ^{\circ}\text{C}$		dV/dt	70	V/ns		
Reverse Diode dV/dt ^d			50			
Soldering Recommendations (Peak temperature) c For 10 s		10 s		300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $V_{DD} = 140 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 28.2 \,\text{mH}$, $R_g = 25 \,\Omega$, $I_{AS} = 9 \,\text{A}$.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 500 A/ μ s, starting $T_J = 25$ °C.



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	40	°C/W		
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.24			

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 10 mA		0.81	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V _{DS} = V _{GS} , I _D = 250 μA		-	4.0	V
0.1. 0		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage	Source Leakage I _{GSS} V _{GS} = ± 30 V		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zoro Cata Valtaga Drain Current		V _{DS} =	V _{DS} = 520 V, V _{GS} = 0 V		-	1	, . ^
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 520 \text{ V}$	', V _{GS} = 0 V, T _J = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30.5 A	-	0.041	0.047	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	30 V, I _D = 30.5 A	-	23	-	S
Dynamic							
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	7407	-	
Output Capacitance	Coss	1	$V_{DS} = 100 V,$	-	351	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz		3	-	pF
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V 0V/1- 500V V 0V		-	233	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	- V _{DS} = 0	$V_{DS} = 0 \text{ V to } 520 \text{ V}, V_{GS} = 0 \text{ V}$		939	-	
Total Gate Charge	Q_g			-	247	371	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 30.5 \text{ A}, V_{DS} = 520 \text{ V}$		65	-	nC
Gate-Drain Charge	Q _{gd}				93	-	
Turn-On Delay Time	t _{d(on)}	V _{DD} = 520 V, I _D = 30.5 A,		-	59	89	- ns
Rise Time	t _r			-	107	161	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		217	326	
Fall Time	t _f			-	133	200]
Gate Input Resistance	R _g	f = 1 MHz, open drain		0.5	1	2	Ω
Drain-Source Body Diode Characteristics	3						
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	64	
Pulsed Diode Forward Current	I _{SM}			-	-	199	A
Diode Forward Voltage	V_{SD}	T _J = 25 °C, I _S = 30.5 A, V _{GS} = 0 V		-	0.9	1.2	V
Reverse Recovery Time	t _{rr}				212	474	ns
Reverse Recovery Charge	Q _{rr}	T _J = 25 °C, I _F = I _S = 30.5 A, dI/dt = 100 A/ μ s, V _R = 400 V		-	2.1	3.8	μC
Reverse Recovery Current	I _{RRM}			-	18	-	Α

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

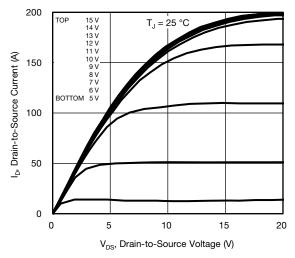


Fig. 1 - Typical Output Characteristics

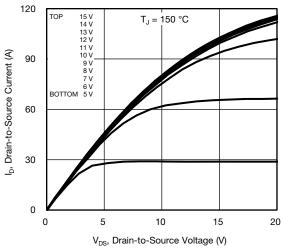


Fig. 2 - Typical Output Characteristics

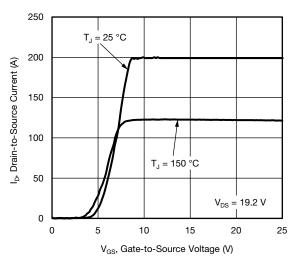


Fig. 3 - Typical Transfer Characteristics

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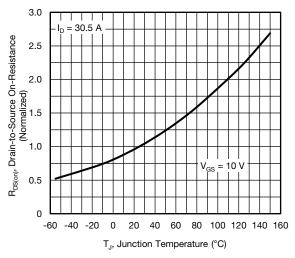


Fig. 4 - Normalized On-Resistance vs. Temperature

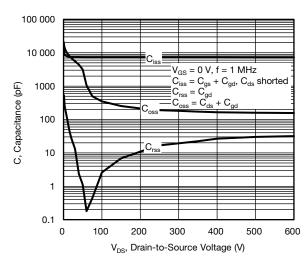


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

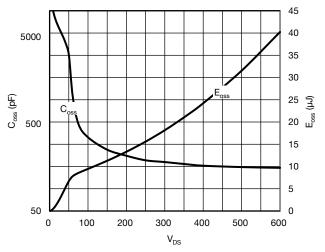


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



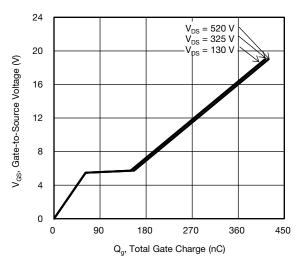


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

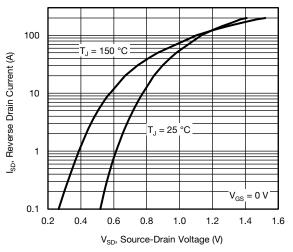


Fig. 8 - Typical Source-Drain Diode Forward Voltage

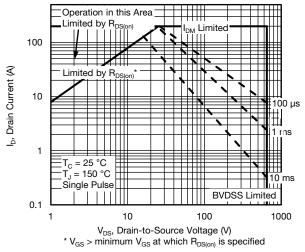


Fig. 9 - Maximum Safe Operating Area

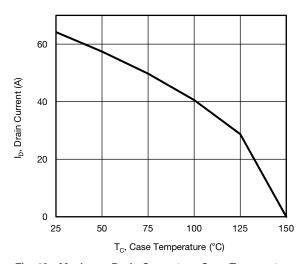


Fig. 10 - Maximum Drain Current vs. Case Temperature

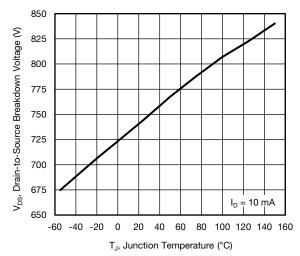


Fig. 11 - Temperature vs. Drain-to-Source Voltage



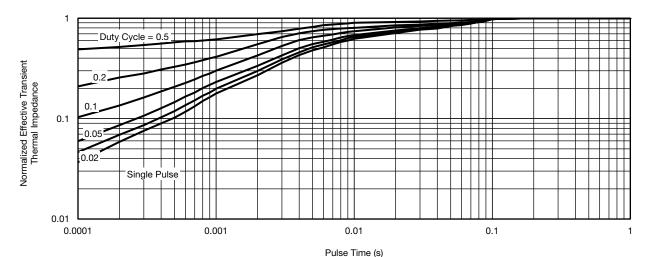


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

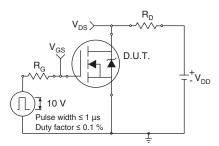


Fig. 13 - Switching Time Test Circuit

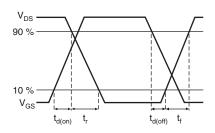


Fig. 14 - Switching Time Waveforms

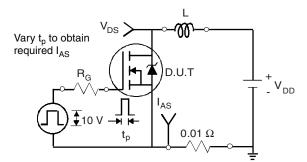


Fig. 15 - Unclamped Inductive Test Circuit

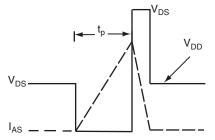


Fig. 16 - Unclamped Inductive Waveforms

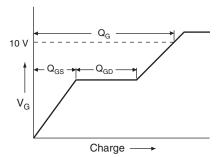


Fig. 17 - Basic Gate Charge Waveform

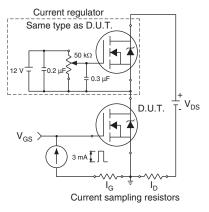
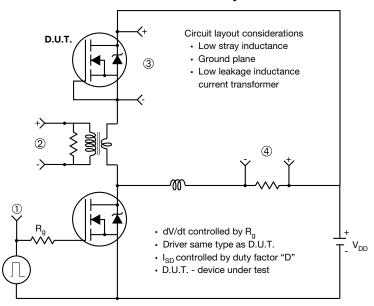


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



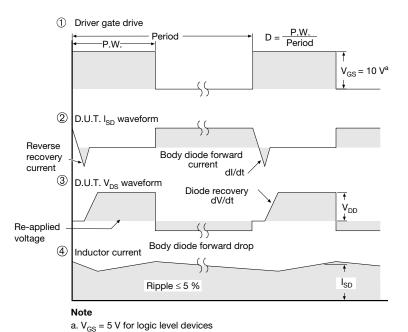
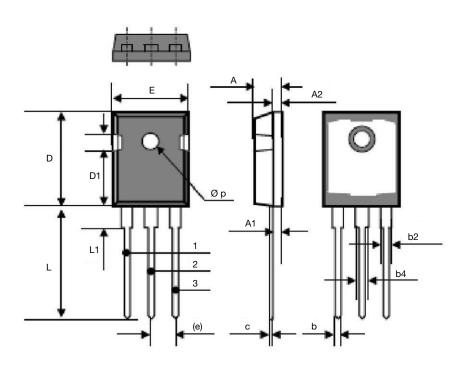


Fig. 19 - For N-Channel

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TO-247AD (High Voltage)



DIM.	MILLII	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.70	5.31	0.185	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b2	1.65	2.41	0.065	0.095	
b4	2.59	3.43	0.102	0.135	
С	0.61 BSC		0.024 BSC		
D	20.80	21.46	0.819	0.845	
D1	3.68	5.49	0.145	0.216	
(e)	5.46 BSC		0.215 BSC		
Е	15.49	16.26	0.610	0.640	
L	19.81	20.32	0.780	0.800	
L1	4.06	4.50	0.160	0.177	
Øр	3.51	3.66	0.138	0.144	
ECN: S17-0178-Rev. B, 0	06-Feb-17	•	•		

ECN: S17-U178-Rev. B, U6-Feb-17

DWG: 6010



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